

· SAW Filter for Digital Television

• Complies with Directive 2002/95/EC (RoHS)



#### Characteristics:

Balance-to-Balanced Operation

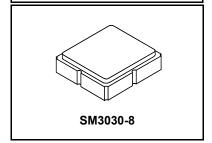
Terminating Source/Load Impedance :  $Z_S = 150 \Omega$ 

#### **Maximum Rating**

Rating	Value	Units
Input Power Level	0	dBm
DC Voltage on any Non-ground Terminal	3	V
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 cycles/ 10 seconds maximum	265	°C

# SF2163E

# 1076.06 MHz **SAW Filter**



#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f <sub>C</sub>			1076.06		MHz
Maximum Insertion Loss, 1056.06 to 1096.06 MHz	IL <sub>MAX</sub>			3.5	5.5	dB
1.5 dB Bandwidth				52		MHz
Amplitude Ripple, 1056.06 to 1096.06 MHz				1.0	2.2	dB
Attenuation, Referenced to IL <sub>MAX</sub>						
50 to 994.04 MHz			45	53		
1158.20 to 3150 MHz			40	50		dB
3150 to 6000 MHz			18	20		
Group Delay Ripple, 1056.06 to 1096.06 MHz				15	40	ns <sub>P-P</sub>

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	859, YWWS
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel
Reel Size 13 Inch	3000 Pieces/Reel

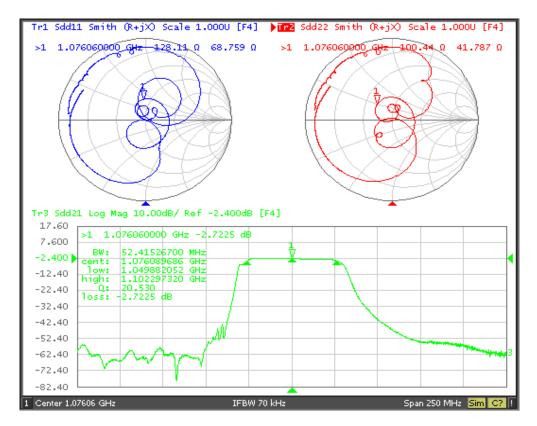
#### **Electrical Connection**

	Connection	Terminals
Port 1	Balanced Input	1,2
Port 2	Balanced Output	5,6
	Ground	All Others
Dot Indicates Pir	1	•

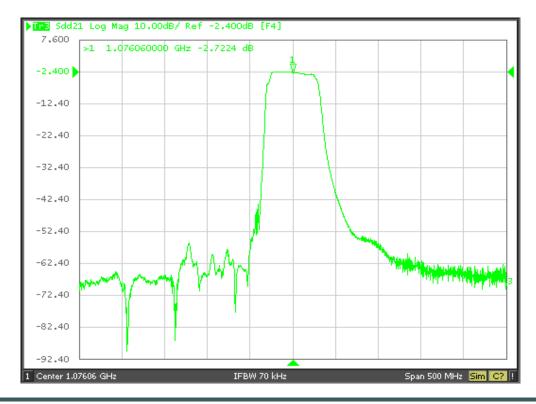
# **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

- US and international patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

# Filter $S_{11}$ , $S_{22}$ and $S_{21}$ Plots



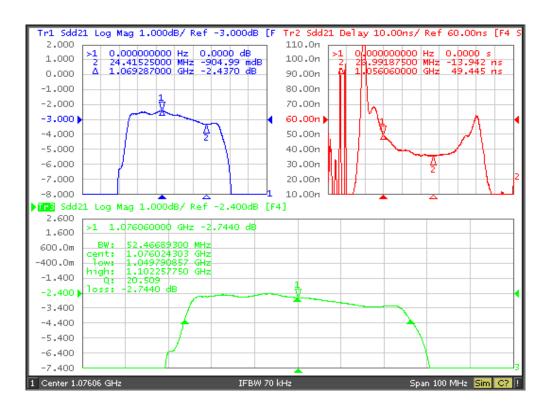
# Filter Near-in Rejection



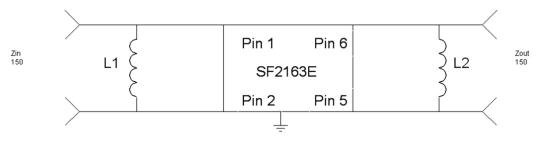
## **Filter Broadband Rejection**



# Filter Passband Amplitude and Group Delay Detail



# Tuning Network, 150 ohm Balanced Source/Load

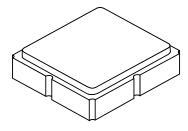


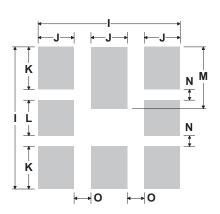
All other pins grounded

L1 22 nH

L2 24 nH

# 8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





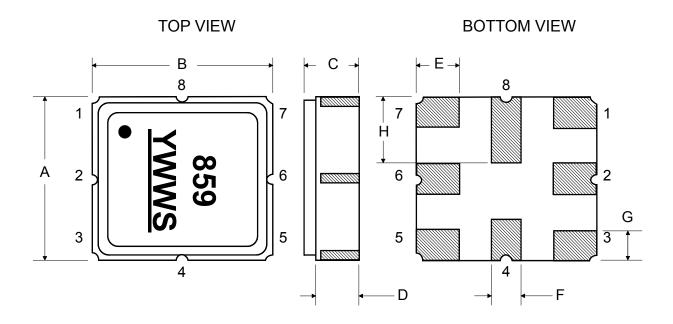
**PCB Footprint Top View** 

### **Case and PCB Footprint Dimensions**

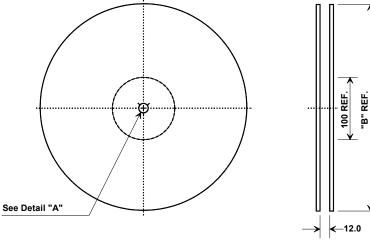
Dimension	mm			Inches		
Dilliension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.0	3.13	0.113	0.118	0.123
В	2.87	3.0	3.13	0.113	0.118	0.123
С	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
Н	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
М		1.39			0.055	
N		0.23			0.009	
0		0.38			0.015	

#### **Case Materials**

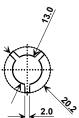
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				



#### **Tape and Reel Specifications**



	"B"	Quantity Per Reel	
Inches	millimeters	Quality 1 of 1001	
7	178	500	
13	330	3000	



#### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions	
Ao	3.35 mm
Во	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

